



JT040K065WED/AED

主要参数 MAIN CHARACTERISTICS

I_C	40 A
V_{CE}	650V
$V_{cesat-typ}(V_{ge}=15V)$	1.7V

用途

- 逆变器
- UPS 电源
- 电机控制

产品特性

- 低栅极电荷
- Trench FS 技术
- RoHS 产品

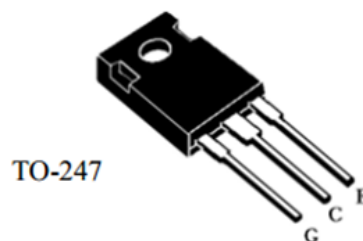
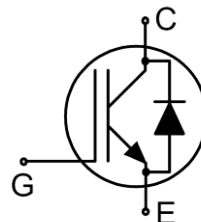
APPLICATIONS

- General purpose inverters
- UPS
- Motor Control

FEATURES

- Low gate charge
- Trench FS Technology,
- RoHS product

封装 Package



订货信息 ORDER MESSAGE

订货型号 Order codes	印记 Marking	封装 Package
无卤-条管 Halogen-Free-Tube		
JT040K065WED-GE-BR	JT040K065WED	TO-247
JT040K065AED-GA-BR	JT040K065AED	TO-3PH

绝对最大额定值 ABSOLUTE RATINGS (T_C=25℃)

项 目 Parameter	符 号 Symbol	数 值 Value		单 位 Unit
		JT040K065WED	JT040K065AED	
最高集电极-发射极直流电压 Collector-Emitter Voltage	V _{CE}	650	650	V
*连续集电极电流 Collector Current-continuous	I _C	80(T _C =25℃)	80(T _C =25℃)	A
		40(T _C =100℃)	40(T _C =100℃)	A
最大脉冲集电极极电流(注1) Collector Current – pulse (note 1)	I _{CM}	160	160	A
二极管正向测试电流 Diode RMS forward current	I _F	80(T _C =25℃)	80(T _C =25℃)	A
		40(T _C =100℃)	40(T _C =100℃)	A
二极管正向脉冲电流 Diode pulse current	I _{FSM}	160	160	A
最高栅极发射极电压 Gate-Emitter Voltage	V _{GE}	±20	±20	V
Turn-off safe area	-	160	160	A
耗散功率 Power Dissipation	P _D T _C =25℃	340	108	W
存储温度 Storage Temperature Range	T _{STG}	-55~+150	-55~+150	℃
结温 Junction Temperature Range	T _{VJ}	-40~+175	-40~+175	℃
引线最高焊接温度 Maximum Lead Temperature for Soldering Purposes	T _L	300	300	℃
绝缘耐压 Isolation Voltage	V _{ISO}	-	1500	V

*连续集电极电流由最高结温限制

*Collector current limited by maximum junction temperature

注释:

1: 脉冲宽度由最高结温限制

Notes:

1: Pulse width limited by maximum junction temperature



电特性 ELECTRICAL CHARACTERISTICS

项 目 Parameter	符 号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units
关态特性 Off –Characteristics						
集电极-发射极击穿电压 Collector-emitter voltage	BV_{CES}	$I_C=250\mu A, V_{GE}=0V$	650	-	-	V
击穿电压温度特性 Breakdown voltage temperature coefficient	$\Delta BV_{CES}/\Delta T_J$	$I_C=0.5mA$, referenced to $25^\circ C$	-	0.6	-	V/ $^\circ C$
零栅压下集电极漏电流 Zero gate voltage collector current	I_{CES}	$V_{CE}=650V, V_{GE}=0V, T_C=25^\circ C$	-	-	40	μA
正向栅极体漏电流 Gate-body leakage current, forward	I_{GESF}	$V_{CE}=0V, V_{GE}=20V$	-	-	200	nA
反向栅极体漏电流 Gate-body leakage current, reverse	I_{GESR}	$V_{CE}=0V, V_{GE}=-20V$	-	-	-200	nA
通态特性 On-Characteristics						
阈值电压 Gate Threshold Voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}, I_C=250\mu A$	4.5	-	6.5	V
饱和压降 Collector-emitter saturation voltage	V_{CESAT}	$V_{GE}=15V, I_C=40A$ $T_C=25^\circ C$ $T_C=175^\circ C$	-	1.7 2.2	2.4 -	V
动态特性 Dynamic Characteristics						
输入电容 Input capacitance	C_{ies}	$V_{CE}=25V,$ $V_{GE}=0V,$ $f=1.0MHz$	-	2392	-	pF
输出电容 Output capacitance	C_{oes}		-	193	-	pF
反向传输电容 Reverse transfer capacitance	C_{res}		-	64.5	-	pF
栅极电荷总量 Total gate charge	Q_g	$V_{CC}=480V, I_C=40A, R_G=10\Omega, V_{GE}=15V$ $T_C=25^\circ C$	-	79.2	-	nC
栅极-发射极 Gate to emitter charge	Q_{ge}		-	24.6	-	
栅极-集电极 Gate to collector charge	Q_{gc}		-	34.1	-	
栅极电阻-Gate resistance	R_g	$f=1 MHz$, open collector	-	1.3	-	Ω
短路电流-Short current	I_{sc}	$V_{GE}=15V, V_{CE} \leq 400V, t \leq 10\mu s$	-	190	-	A





电特性 ELECTRICAL CHARACTERISTICS

开关特性 Switching Characteristics

项 目 Parameter	符 号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units
开启延迟时间 Turn-on delay time	$t_d(\text{on})$	$V_{CC}=400V, I_c=40A, R_G=10.5\Omega$ $V_{GE}=15V$ $T_C=25^\circ C$	-	24	-	ns
上升时间 Turn-on rise time	t_r		-	84	-	ns
关断延迟时间 Turn-off delay time	$t_d(\text{off})$		-	70	-	ns
下降时间 Turn-off Fall time	t_f		-	78	-	ns
开通损耗 Turn-on energy	E_{on}		-	1.11	-	mJ
关断损耗 Turn-off energy	E_{off}		-	1.11	-	mJ
总开关损耗 Total switching energy	E_{tot}		-	2.22	-	mJ
开启延迟时间 Turn-on delay time	$t_d(\text{on})$	$V_{CC}=400V, I_c=40A, R_G=10.5\Omega$ $V_{GE}=15V$ $T_C=175^\circ C$	-	30	-	ns
上升时间 Turn-on rise time	t_r		-	78	-	ns
关断延迟时间 Turn-off delay time	$t_d(\text{off})$		-	96	-	ns
下降时间 Turn-off fall time	t_f		-	160	-	ns
开通损耗 Turn-on energy	E_{on}		-	1.13	-	mJ
关断损耗 Turn-off energy	E_{off}		-	1.25	-	mJ
总开关损耗 Total switching energy	E_{tot}		-	2.38	-	mJ

反并联二极管特性及最大额定值 Anti-Parallel Diode Characteristics and Maximum Ratings

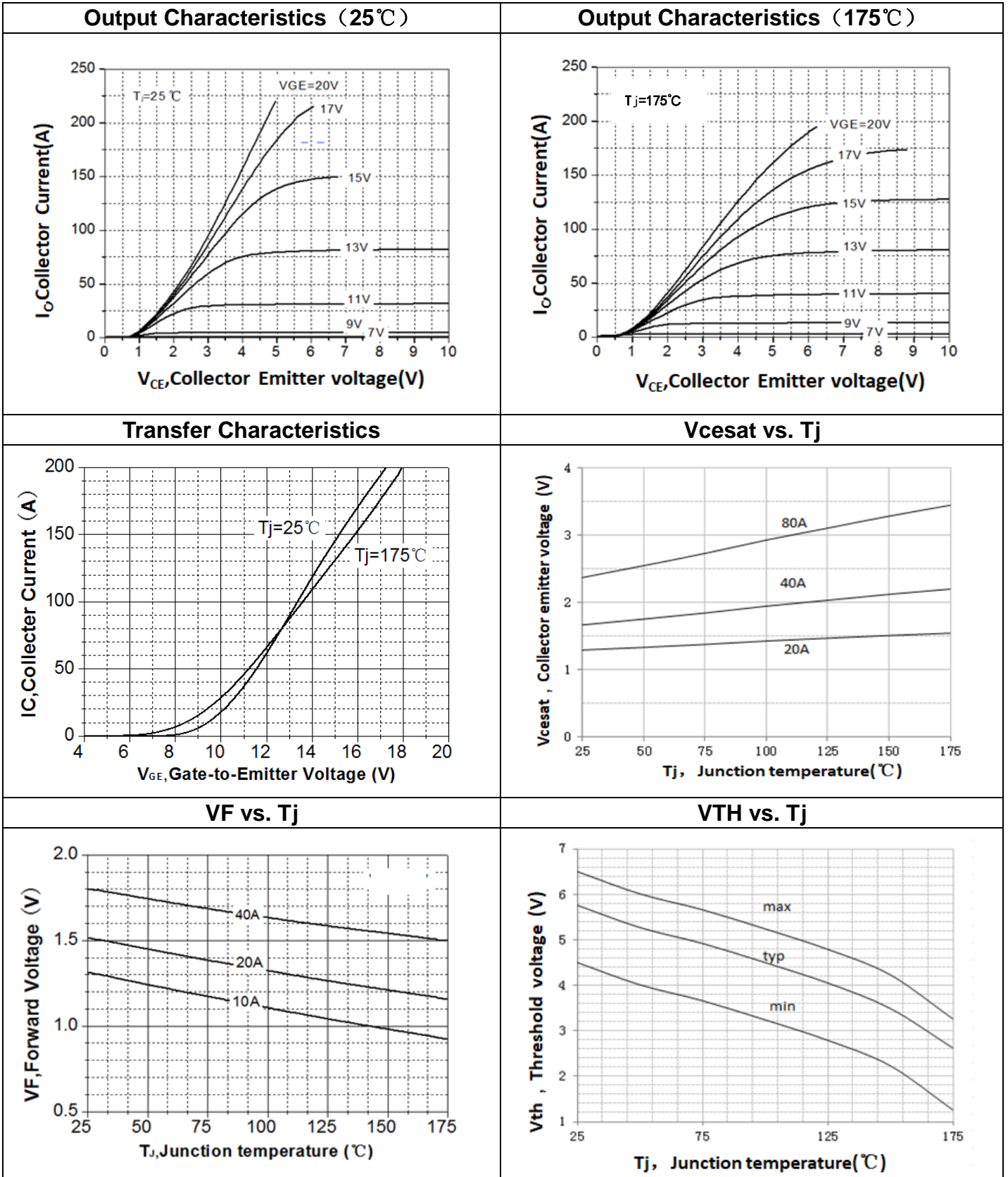
正向压降 Diode forward Voltage	V_F	$V_{GE}=0V, I_F=20A, T_C=25^\circ C$	-	1.5	2.5	V
		$V_{GE}=0V, I_F=20A, T_C=175^\circ C$	-	1.15	-	V
反向恢复时间 Diode reverse recovery time	t_{rr}	$V_{GE}=0V, V_R=400V, I_F=15A$	-	36	-	ns
反向恢复电荷 Diode reverse recovery charge	Q_{rr}	$dl_F/dt=1000A/\mu s$	-	0.3	-	μC
反向恢复电流 Diode reverse recovery Current	I_{rrm}	$T_C=25^\circ C$	-	10	-	A
反向恢复时间 Diode reverse recovery time	t_{rr}	$V_{GE}=0V, V_R=400V, I_F=15A$	-	116	-	ns
反向恢复电荷 Diode reverse recovery charge	Q_{rr}	$dl_F/dt=1000A/\mu s$	-	1.1	-	μC
反向恢复电流 Diode reverse recovery Current	I_{rrm}	$T_C=175^\circ C$	-	15.8	-	A

项 目 Parameter	符 号 Symbol	MAX		单 位 Unit
		JT040K065WED	JT040K065AED	
结到管壳的热阻 Thermal resistance, Junction to case IGBT	$R_{th(j-c)}$	0.44	1.38	$^\circ C/W$
结到管壳的热阻 Thermal resistance, Junction to case diode	$R_{th(j-c)}$	0.81	2.08	$^\circ C/W$
结到环境的热阻 Thermal resistance, Junction to ambient	$R_{th(j-A)}$	40	40	$^\circ C/W$



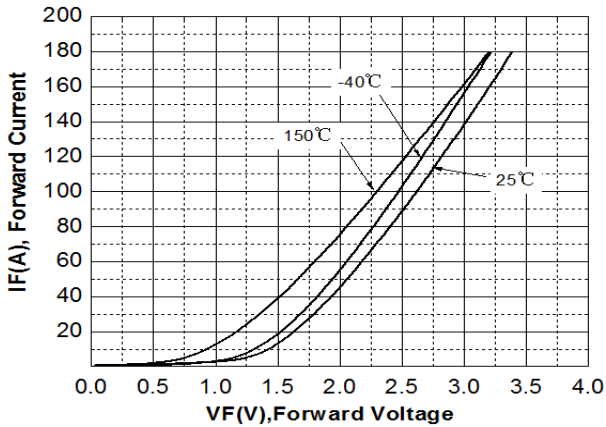


特征曲线 ELECTRICAL CHARACTERISTICS (curves)



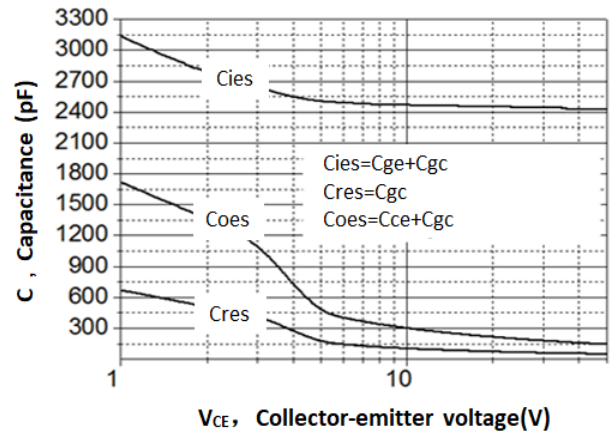


Diode Characteristic



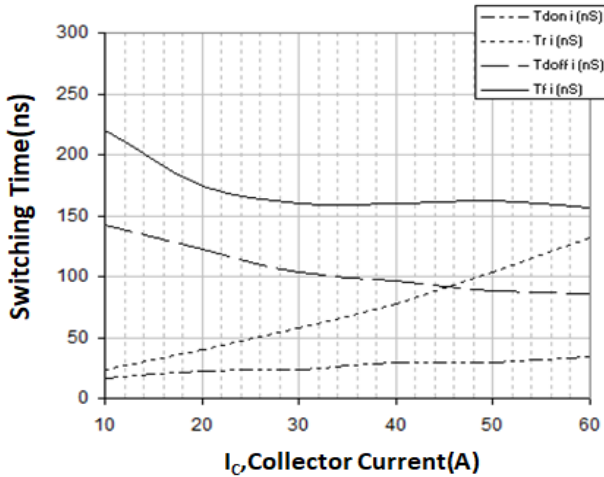
Capacitance Characteristic

VGE = 0V, f = 1.0MHz



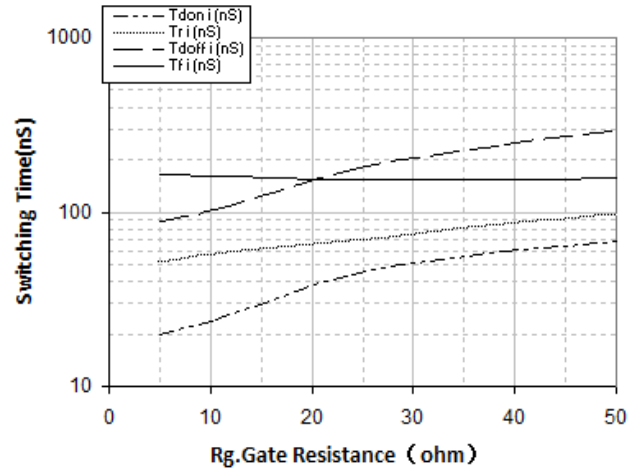
Switching Time vs. IC(175°C)

VGE=15V, VCE=400V, RG=10.5Ω



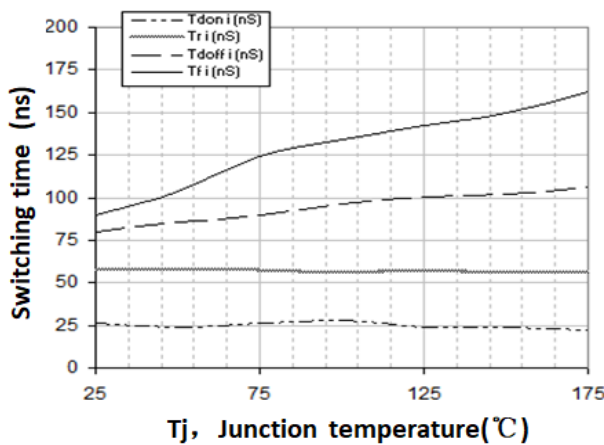
Switching Time vs. Rg(175°C)

VGE=15V, VCE=400V, IC=40A



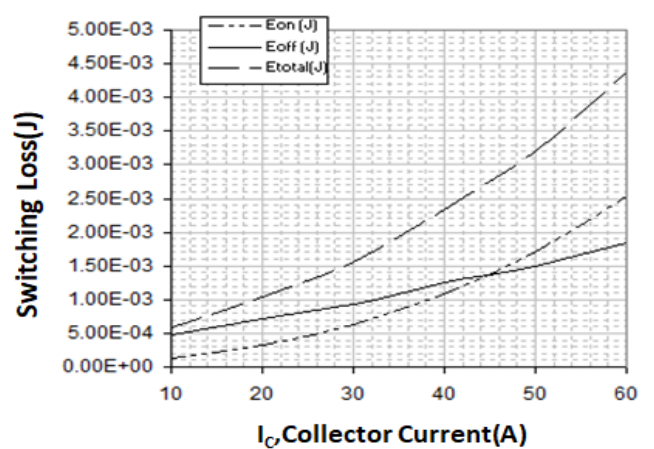
Switching Time vs. Tj

VGE=15V, VCE=400V, IC=40A, Rg=10.5Ω



Switching Loss vs. IC(175°C)

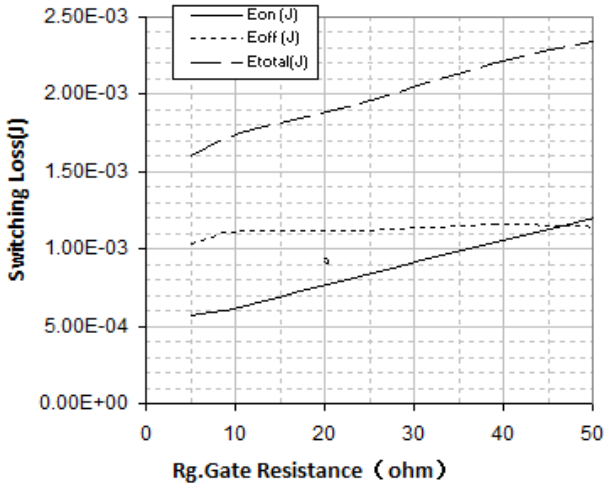
VGE=15V, VCE=400V, Rg=10.5Ω





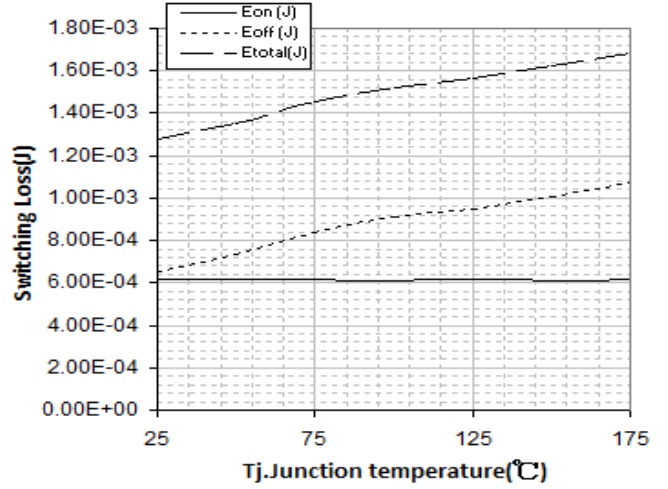
Switching Loss vs. Rg(175°C)

VGE=15V, VCE=400V, IC=40A

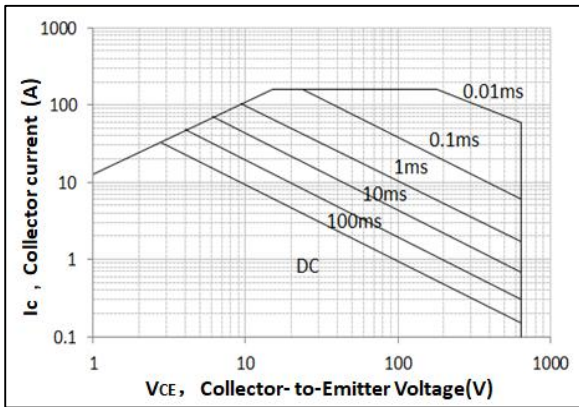


Switching Loss vs. Tj

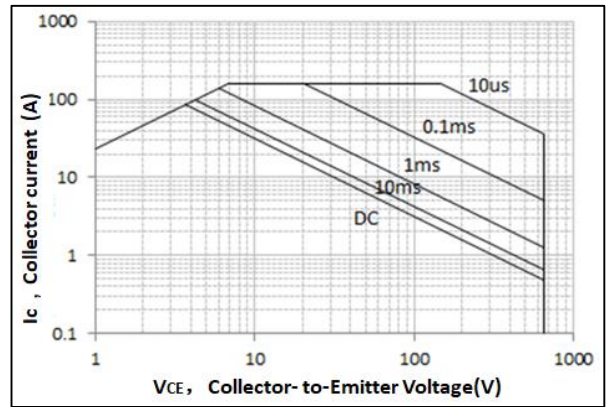
VGE=15V, VCE=400V, IC=40A, Rg=10.5Ω



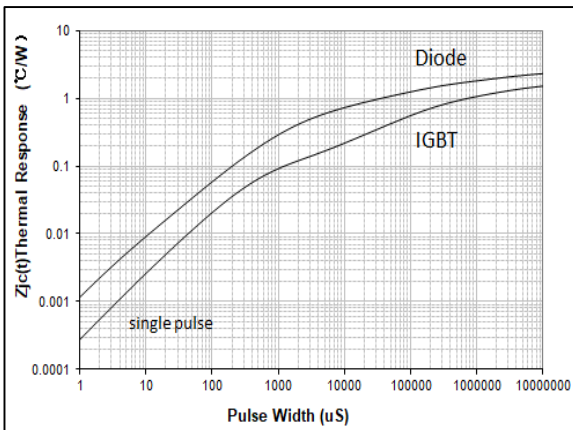
Forward Bias SOA(TO-3PH)



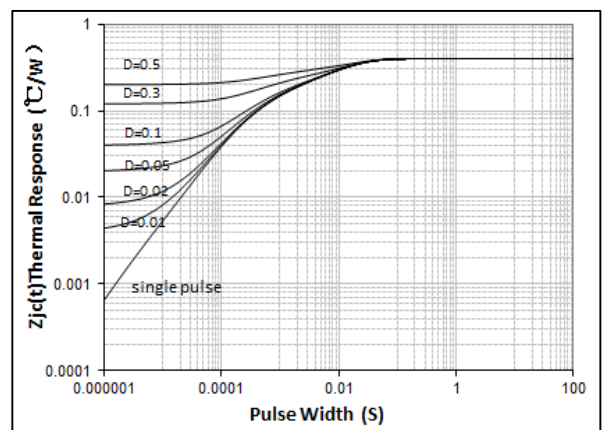
Forward Bias SOA(TO-247)



Transient Thermal Impedance (TO-3PH)

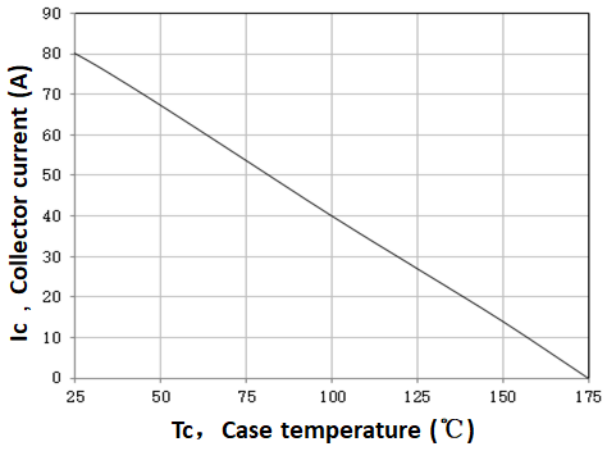


Transient Thermal Impedance for IGBT (TO-247)



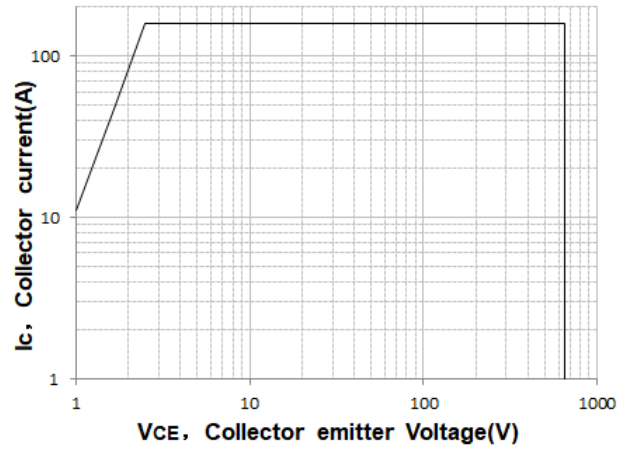


Ic vs.Tc



Reverse Bias Safe Operating Area

Tc=25°C VGE=±15V, Rg=10 Ω

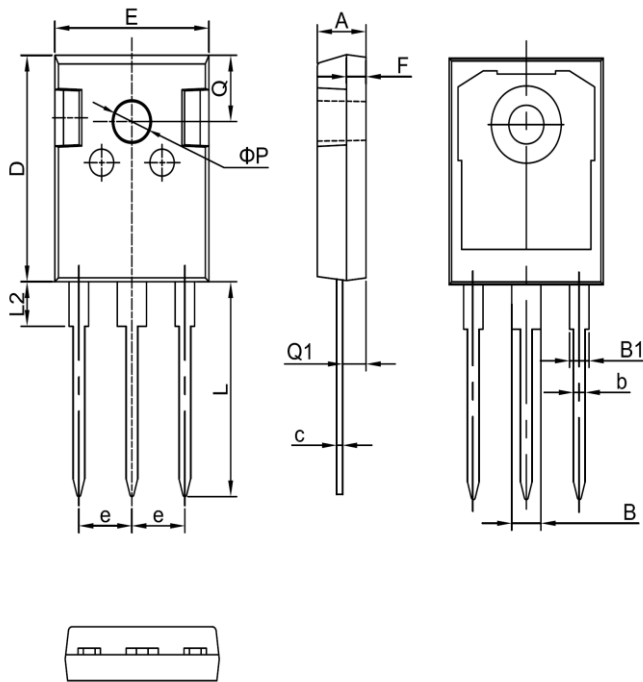




外形尺寸 PACKAGE MECHANICAL DATA

TO-247

单位 Unit : mm

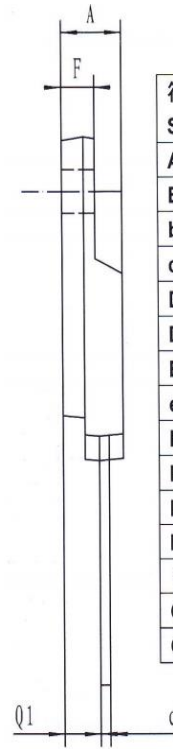
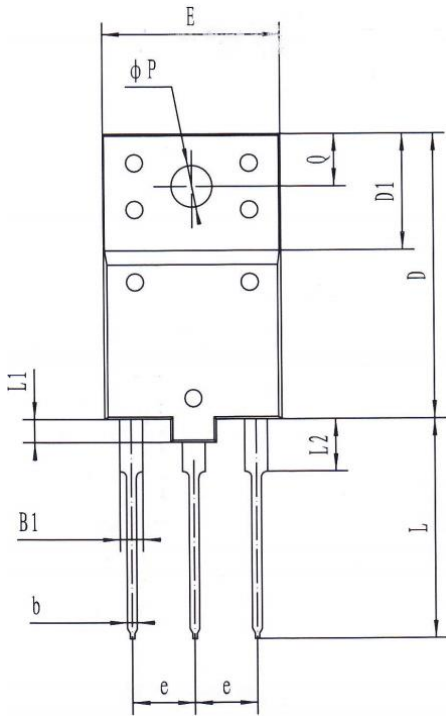


符号 symbol	MIN	MAX
A	4.90	5.10
B	2.95	3.35
B1	1.95	2.35
b	1.15	1.35
c	0.50	0.70
D	20.90	21.10
E	15.70	15.90
e	5.34	5.54
F	1.90	2.10
L	19.40	20.40
L2	4.03	4.23
Q	6.00	6.40
Q1	2.30	2.50
P	3.50	3.70



外形尺寸 PACKAGE MECHANICAL DATA

TO-3PH



符号 Symbol	Min	Max
A	5.2	5.8
B1	1.8	2.2
b	0.75	1.05
c	0.8	1.1
D	24.0	25.0
D1	9.8	10.2
E	15.0	16.0
e	5.45 (typ)	
F	2.7	3.3
L	18.5	19.5
L1	1.8	2.2
L2	4.3	4.7
φP	3.4	3.8
Q	4.3	4.7
Q1	3.1	3.5



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联系方式

吉林华微电子股份有限公司

公司地址：吉林省吉林市深圳街 99 号

邮编：132013

总机：86-432-64678411

传真：86-432-64665812

网址：www.hwdz.com.cn

CONTACT

JILIN SINO-MICROELECTRONICS CO., LTD.

ADD: No.99 Shenzhen Street, Jilin City, Jilin Province, China.

Post Code: 132013

Tel: 86-432-64678411

Fax: 86-432-64665812

Web Site: www.hwdz.com.cn